

MOSFET

OptiMOS[™] 3 Power-Transistor, 60 V

Features

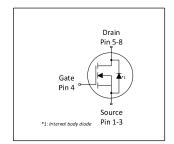
- Ideal for high frequency switching and sync. rec.
 Optimized technology for DC/DC converters
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
- Superior thermal resistance
- N-channel, normal level

- 100% avalanche tested
 Pb-free plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21



Parameter	Value	Unit
$V_{ extsf{DS}}$	60	V
R _{DS(on),max}	3.1	mΩ
I _D	165	A











Type / Ordering Code	Package	Marking	Related Links
BSC031N06NS3 G	PG-TDSON-8	031N06NS	-



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

D	Constant	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	ID	-	-	165 105 22	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =10V, T_{C} =25 °C, R_{thJA} =50K/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	660	Α	T _C =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	298	mJ	I_{D} =50 A, R_{GS} =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	139 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =50 K/W ²⁾	
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56	

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Candition	
raiailletei	Symbol	Min. Typ. Max.	Offic	Note / Test Condition			
Thermal resistance, junction - case	R_{thJC}	-	-	0.9	K/W	-	
Device on PCB, minimal footprint	R_{thJA}	-	-	62	K/W	-	
Device on PCB, 6 cm² cooling area ²⁾	R_{thJA}	_	_	50	K/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

³⁾ See Diagram 3 for more detailed information⁴⁾ See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 Static characteristics

			Values				
Parameter	Symbol	Min.	lin. Typ. Max.		Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2.0	3.0	4.0	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=93\ \mu {\rm A}$	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μΑ	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	2.5	3.1	mΩ	V _{GS} =10 V, I _D =50 A	
Gate resistance	R _G	-	1.3	-	Ω	-	
Transconductance	g_{fs}	50	99	-	S	V _{DS} >2 I _D R _{DS(on)max} , I _D =50 A	

Table 5 **Dynamic characteristics**

Parameter	O l l	Values				
Parameter	r Symbol Min. Typ. Max.		Unit	Note / Test Condition		
Input capacitance ¹⁾	Ciss	-	8000	11000	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	1700	2300	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Reverse transfer capacitance	C _{rss}	-	58	-	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	_	38	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =90 A, $R_{\rm G}$ =3 Ω
Rise time	t _r	_	161	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =90 A, $R_{\rm G}$ =3 Ω
Turn-off delay time	$t_{ m d(off)}$	-	63	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =90 A, $R_{\rm G}$ =3 Ω
Fall time	t _f	-	16	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =90 A, $R_{\rm G}$ =3 Ω

Gate charge characteristics²⁾ Table 6

Donomotor	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min. Typ. Max.	Unit	Note / Test Condition		
Gate to source charge	Q _{gs}	-	39	-	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	24	-	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate to drain charge	Q_{gd}	-	8	-	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Switching charge	Q _{sw}	-	23	-	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Qg	-	98	130	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.9	-	V	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	79	105	-	V _{DD} =30 V, V _{GS} =0 V

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition

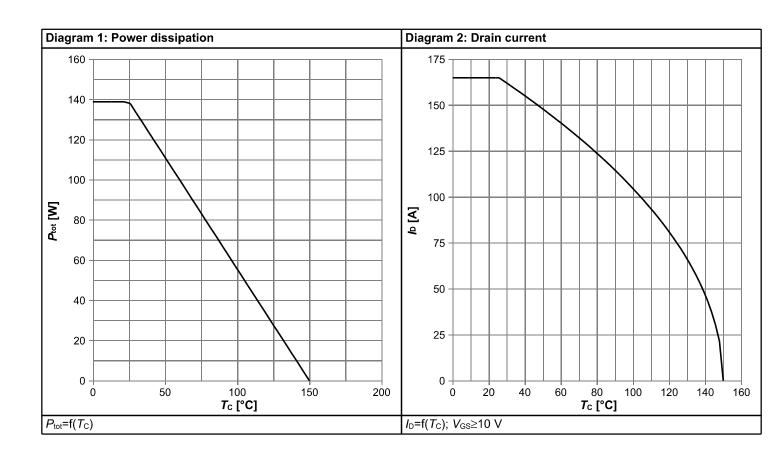


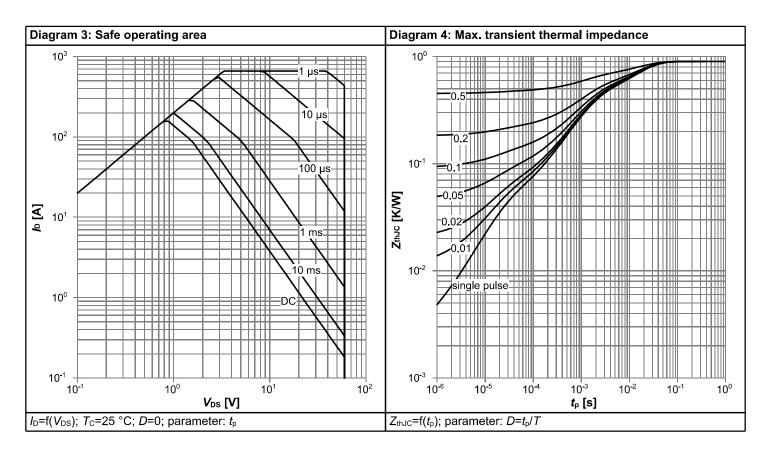
Table 7 Reverse diode

Davamatav	Symbol		Values			Nata / Tank Camalikian	
Parameter	Symbol Mi	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	I _S	-	_	104	Α	T _C =25 °C	
Diode pulse current	I _{S,pulse}	-	_	660	Α	T _C =25 °C	
Diode forward voltage	V _{SD}	-	0.86	1.2	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C	
Reverse recovery time	t _{rr}	-	48	-	ns	V _R =30 V, I _F =90A, dI _F /dt=100 A/μs	
Reverse recovery charge	Q _{rr}	-	73	-	nC	V _R =30 V, I _F =90A, di _F /dt=100 A/μs	

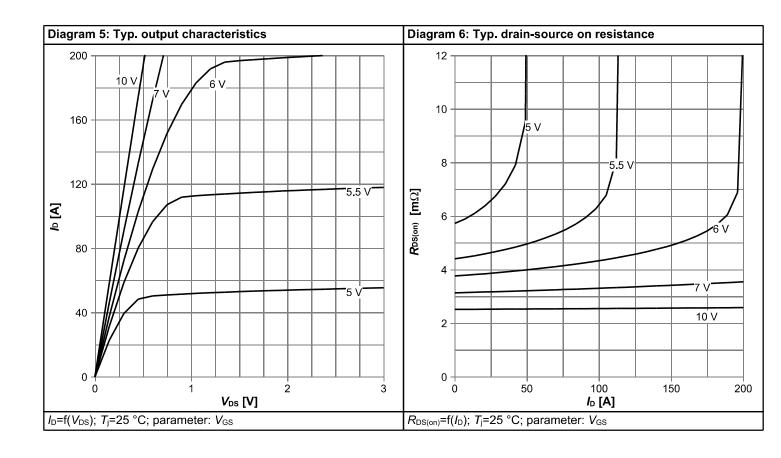


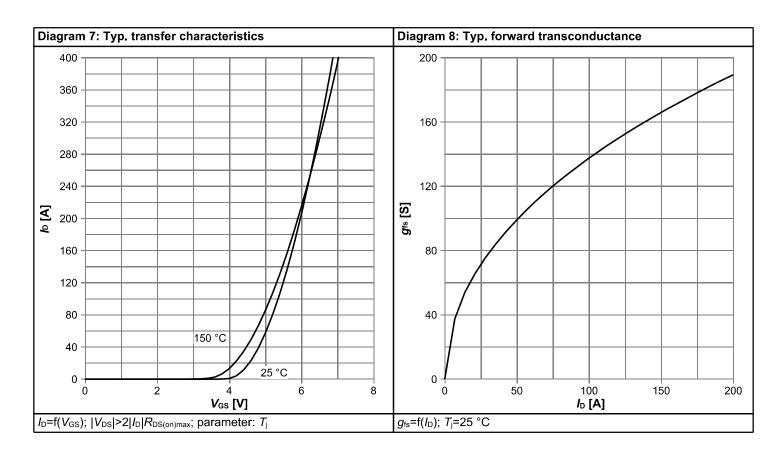
4 Electrical characteristics diagrams



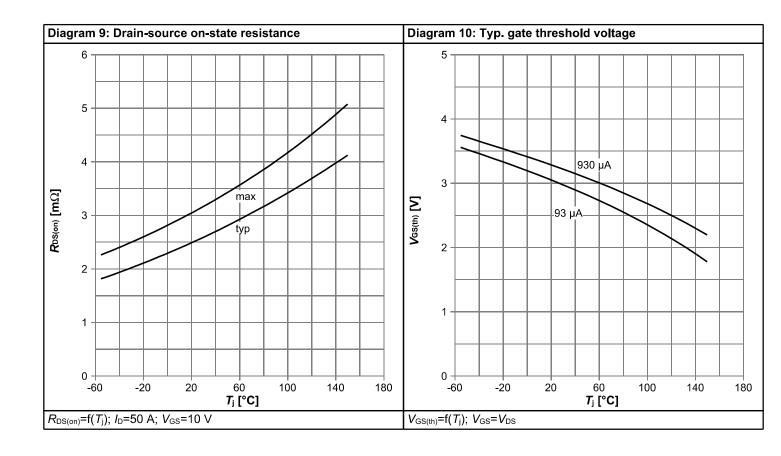


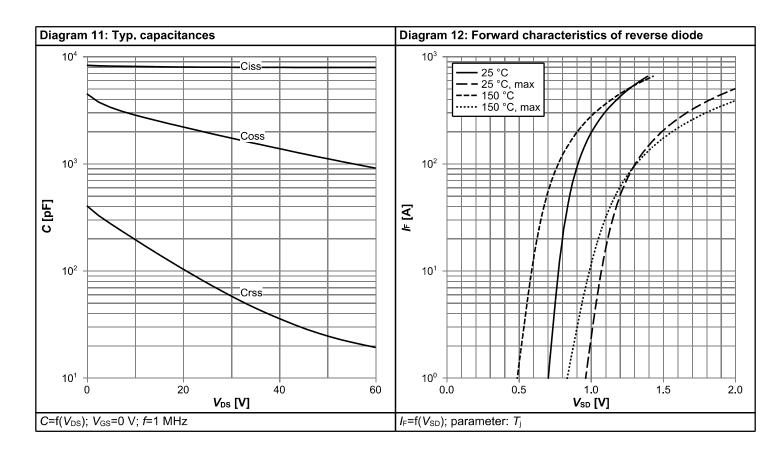




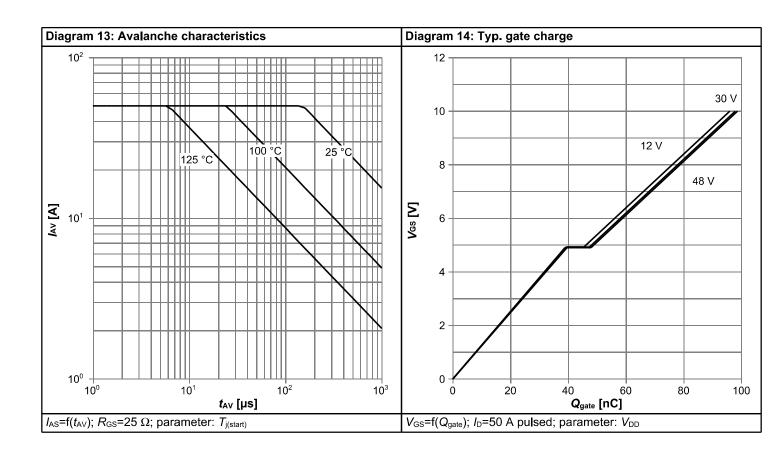


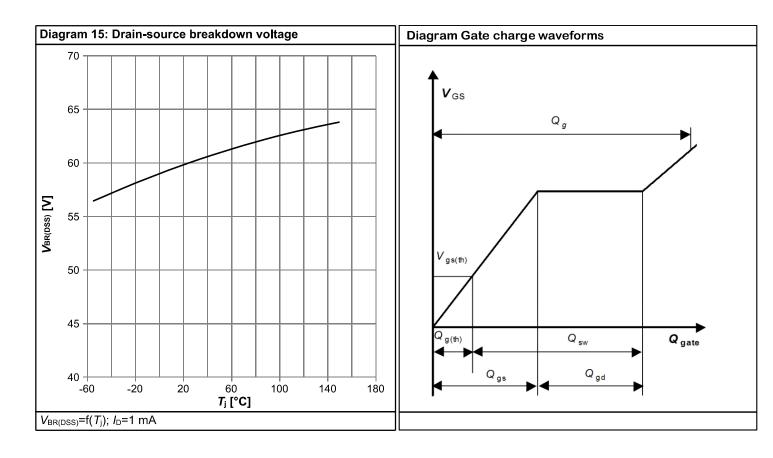






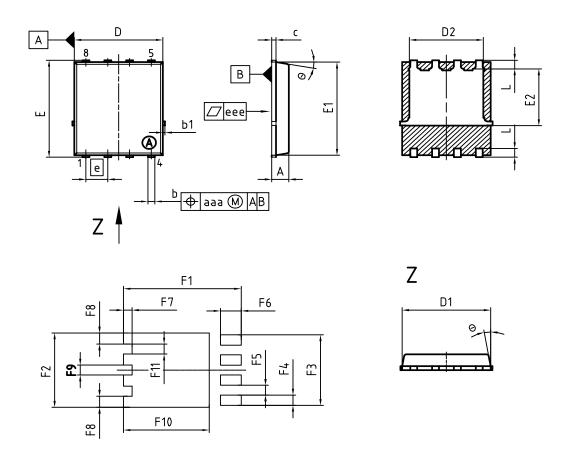








5 Package Outlines



DIM	MILLIN	IETERS	INCHES				
DIM	MIN	MAX	MIN	MAX			
Α	0.90	1.10	0.035	0.043			
b	0.34	0.54	0.013	0.021			
b1	0.02	0.22	0.001	0.008			
С	0.15	0.35	0.006	0.014			
D=D1	4.95	5.35	0.195	0.211			
D2	4.20	4.40	0.165	0.173			
E	5.95	6.35	0.234	0.250			
E1	5.70	6.10	0.224	0.240			
E2	3.40	3.80	0.134	0.150			
е	1.2	27	0.050				
N		8	8				
L	0.45	0.65	0.018	0.026			
Θ	8.5°	11.5°	8.5°	11.5°			
aaa	0.2	25	0.0)10			
eee	0.0	05	0.002				
F1	6.75	6.95	0.266	0.274			
F2	4.60	4.80	0.181	0.189			
F3	4.36	4.56	0.172	0.180			
F4	0.55	0.75	0.022	0.030			
F5	0.52	0.72	0.020	0.028			
F6	1.10	1.30	0.043	0.051			
F7	0.40	0.60	0.016	0.024			
F8	0.60	0.80	0.024	0.031			
F9	0.53	0.73	0.021	0.029			
F10	4.90	5.10	0.193	0.201			
F11	0.53	0.73	0.021	0.029			

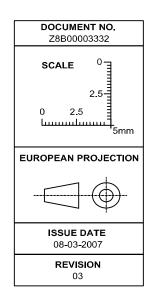


Figure 1 Outline PG-TDSON-8, dimensions in mm/inches



Revision History

BSC031N06NS3 G

Revision: 2021-04-29, Rev. 2.4

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.4	2021-04-29	Update current rating and footnotes

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